General Purpose ASA, KIBILAC® PW-957

Processing Conditions

A. Pre-drying  80°C x 2~3 hrs
   depending on  a) Humidity
                b) Ratio of reground resin
                c) Storage conditions

B. Barrel Setting Profile

   MAX(°C) 240 240 230
   MIN(°C) 200 200 190

C. Mold Temperature  40~80°C
   depending on  a) Thickness
                b) Dimension
                c) Gate and runner system

NOTE:
1. Keep the resin from dust and contamination during handling and production.
2. Do not retain the hot melt at the barrel for a long time between injection cycles.
3. Temperature setting of manifold system should not exceed 240°C to avoid melt from degrading.

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